



Vectron's VT-802 Temperature Compensated Crystal Oscillator (TCXO) is a quartz stabilized, CMOS output, analog temperature compensated oscillator, operating off either 2.5 or 3.3 volt supply in a hermetically sealed 5.0 x 3.2 ceramic package.

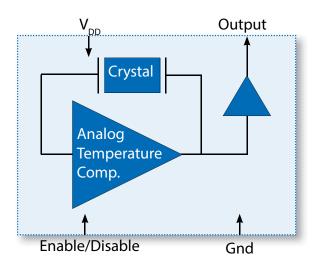
#### **Features**

- CMOS Output
- Low Power
- Output Frequencies to 50 MHz
- Low Jitter Fundamental Crystal Design
- Hermetically Sealed Ceramic SMD package
- Product is compliant to RoHS directive and fully compatible with lead free assembly

## **Applications**

- WiMAX, Wi-Fi, Wi-LAN
- Wireless Communications
- Base Stations
- Point to point radios
- Broadband Access

### **Block Diagram**



# **Specifications**

Table 1. Electrical Performance					
Parameter	Symbol	Min.	Тур	Max	Units
Output Frequency	f <sub>o</sub>	2		50	MHz
Supply Voltage <sup>1</sup> , Ordering Option	V <sub>DD</sub>		+2.5 or +3.3		V
Supply Current, 5 to 19.999MHz 20.000 to 50.0000MHz	I <sub>DD</sub>			3 5	mA mA
Operating Temperature, Ordering Option	T <sub>OP</sub>	-	20/70 or -40/85	5	°C
	STA	BILITY			
Stability Over T <sub>op</sub> Ordering Option		±2.	0, ±2.5, ±5.0 or	±10	ppm
Initial Accuracy <sup>2</sup>				±1.0	ppm
Power Supply Stability				±0.5	ppm
Load Stability				±0.2	ppm
Aging				±1.0	ppm/yr
	OU	TPUT			
Output Logic High <sup>3</sup> Output Logic Low	V <sub>OH</sub> V <sub>OL</sub>	0.9*V <sub>DD</sub>		0.1*V <sub>DD</sub>	V
Output Load				15	pF
Output Rise and Fall Time	t <sub>R</sub> /t <sub>F</sub>			6	ns
Duty Cycle		45		55	%
Phase Noise <sup>4</sup> , 12.800MHz 10Hz 100Hz 1kHz 10kHz 100kHz	0 <sub>N</sub>		-70 -108 -138 -155 -159		dBc/Hz
Start Up Time	t <sub>su</sub>			2	ms
	Enable Dis	able Function			
Input Logic High⁵ Input Logic Low	V <sub>IH</sub> V <sub>IL</sub>	0.3*V <sub>DD</sub>		0.7*V <sub>DD</sub>	V V
Package			5x3.2x1.1		mm

1. The VT-802 power supply pin should be filtered, eg, a 0.1 and 0.01 uf capacitor.

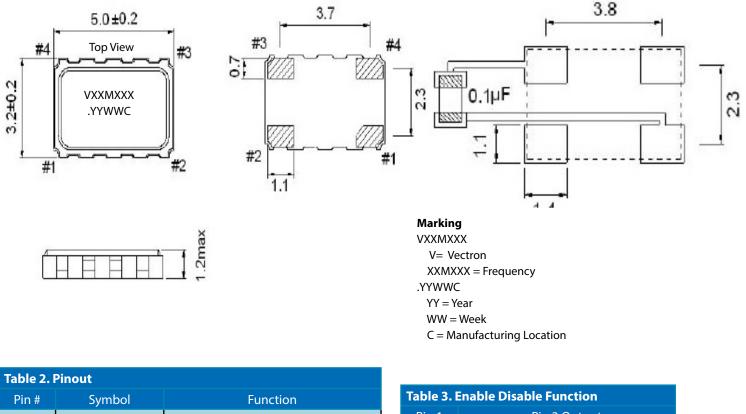
2. initial Accuraccy before reflow. Allow an additional ±1 ppm shift theough 2 reflows, after 24 hours...

3. The Output is DC coupled.

4. Measured at room ambient temperature using an Agilent E5052B Signal Source Analyzer.

5. The Output is active if the Enable Disable is left open.

## **Outline Drawing and Recommended Layout**



Pin #	Symbol	Function
1	E/D	Enable/Disable Function
2	GND	Electrical and Lid Ground
3	f <sub>o</sub>	Output Frequency
4	V <sub>DD</sub>	Supply Voltage

Table 3. Enable Disable Function					
Pin 1	Pin 3 Output				
High	Clock Output				
Open Clock Output					
Low	High Impedance				

## **Maximum Ratings**

#### **Absolute Maximum Ratings and Handling Precautions**

Stresses in excess of the absolute maximum ratings can permanently damage the device. Functional operation is not implied or any other excess of conditions represented in the operational sections of this data sheet. Exposure to absolute maximum ratings for extended periods may adversely affect device reliability.

Although ESD protection circuitry has been designed into the VT-802, proper precautions should be taken when handling and mounting, Vectron employs a Human Body Model and Charged Device Model for ESD susceptibility testing and design evaluation.

ESD thresholds are dependent on the circuit parameters used to define the model. Although no industry standard has been adopted for the CDM a standard resistance of 1.5kOhms and capacitance of 100pF is widely used and therefor can be used for comparison purposes.

Table 4. Maximum Ratings			
Parameter	Symbol	Rating	Unit
Storage Temperature	T <sub>store</sub>	-55/125	∘⊂
E/D Voltage	E/D	0/V <sub>DD</sub>	V
ESD, Human Body Model		1000	V
ESD, Charged Device Model		1000	V

Table 5. Environmental Compliance			
Parameter	Condition		
Mechanical Shock	MIL-STD-883 Method 2002		
Mechanical Vibration	MIL-STD-883 Method 2007		
Temperature Cycle	MIL-STD-883 Method 1010		
Solderability	MIL-STD-883 Method 2003		
Fine and Gross Leak	MIL-STD-883 Method 1014		
Resistance to Solvents	MIL-STD-883 Method 2015		
Moisture Sensitivity Level	MSL1		
Contact Pads	Gold over Nickel		

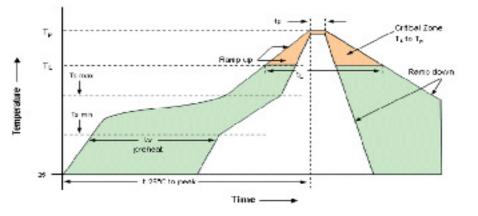
## **IR Reflow**

#### Suggested IR Profile

Devices are built using lead free epoxy and can be subjected to standard lead free IR reflow conditions shown in Table 5. Contact pads are gold over nickel and lower maximum temperatures can also be used, such as 220C.

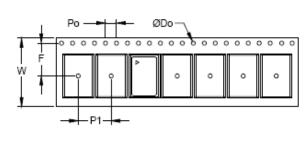
Table 6. Reflow Profile		
Parameter	Symbol	Value
PreHeat Time Ts-min Ts-max	t <sub>s</sub>	200 sec Max 150℃ 200℃
Ramp Up	R <sub>UP</sub>	3°C/sec Max
Time above 217C	t	150 sec Max
Time to Peak Temperature	t <sub>25C to peak</sub>	480 sec Max
Time at 260C	t <sub>p</sub>	30 sec Max
Time at 240C	t <sub>P2</sub>	60 sec Max
Ramp down	R <sub>DN</sub>	6°C/sec Max

### Solderprofile:



# Tape & Reel

Table 7. Tape and Reel Information												
	Tape Dimensions (mm)			Reel Dimensions (mm)								
w	F	Do	Ро	P1	А	В	С	D	N	W1	W2	#/Reel
12	5.5	1.5	4	4	178	2.5	13	22	60	11.5	15	1000



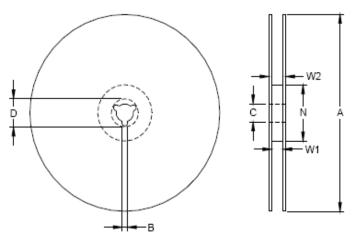
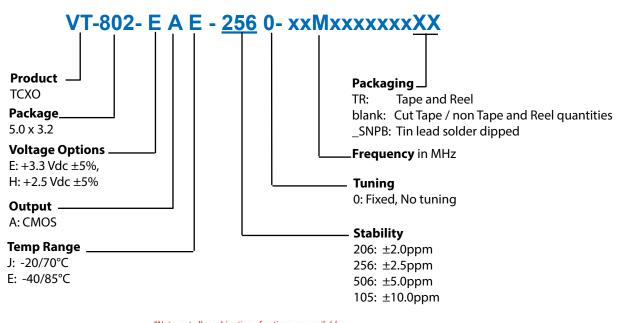


Table 8. Stand	ard Frequen	cies (MHz)							
2.04815328	10.000	12.800	14.7456	16.384	19.200	19.440	20.000	25.000	26.000
27.000	32.000	40.000	50.000						

## **Ordering Information**



\*Note: not all combination of options are available. Other specifications may be available upon request.

Revision History						
Revision Date	Approved	Description				
Aug 10, 2018	FB	Update logo and contact information, add "SNPBDIP" ordering option				
Dec 31, 2019	FB	Update logo and contact information, change "SNPBDIP" to "SNPB", update tape and reel width to 12mm				
April 30, 2020	FB	Add tape and reel ordering option				

### **Contact Information**

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